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[^0]
# FSHDMI08 — Low－Voltage，Wide－Bandwidth， HDMI Switch with DDC and CEC Multiplexer 

## Features

－－25db Non－Adjacent Channel Crosstalk at 1．65Gbps
－Low Signal Loss：-1.5 dBg attenuation at 1.65 Gbps
－Isolation Ground Between Channels
－Fast Turn－on／off Time（＜6ns）
－1．65Gbps Throughput
－8kV ESD Protection
－Low Skew：Intra－pair＜90ps，Inter－pair＜150ps
－Low Power Consumption： $1 \mu \mathrm{~A}$ Maximum
Applications
－XGA and 720p DVI and HDMI Video Source Selection

## Description

The FSHDMI08 is a wide－bandwidth switch designed for routing HDMI link data，clock，and the relevant DDC and CEC control signals that support the data rate up to 1.65 Gbps per channel for UXGA resolution． Applications include LCD TVs，DVD，set－top boxes，and notebook designs with multiple digital video interfaces．

This switch allows the passage of HDMI link signals with ultra－low non－adjacent channel crosstalk and ultra－ low off isolation．This is critical to minimize ghost images between active video sources in video applications．The wide bandwidth of this switch allows the high－speed differential signal to pass through with minimal additive skew and phase jitter．The pinout supports an HDMI standard－A connector PCB layout．

## IMPORTANT NOTE：

For additional information，please contact analogswitch＠fairchildsemi．com．

Ordering Information

| Order Number | Eco Status | Package Description | Packing Method |
| :---: | :---: | :---: | :---: |
| FSHDMI08MTDX | RoHS | 56－Lead，Thin Shrink Small Outline Package（TSSOP）， <br> JEDEC MO－153，6．1mm Wide | Tape and Reel |

For Fairchild＇s definition of Eco Status，please visit：http：／／www．fairchildsemi．com／company／green／rohs green．html．


Figure 1．Single－Link HDMI Application

## Functional Diagram



Figure 2. Functional Diagram

## Pin Descriptions

| Pin | Name | Description |
| :---: | :---: | :---: |
| $\begin{aligned} & \hline 1-4,6,7,11-14,16,17 \\ & 47,48,50,51,53,54 \\ & \hline \end{aligned}$ | 1Dn+, 1Dn-, 2Dn+, 2Dn-, Dn+, Dn- | TMDS Data Channels |
| 8,9,18,19,44,45 | 1CLK+, 1CLK-, 2CLK+, 2CLK-, CLK+, CLK- | TMDS Clock Channels |
| 24,28,33 | HPD1, HPD2, HPD | Hot Plug Detects |
| 22,26,35 | SCL1, SCL2, SCL | Serial Clock (DDC) |
| 23,27,34 | SDA1, SDA2, SDA | Serial Data (DDC) |
| 21,25,36 | CEC1, CEC2, CEC | Consumer Electronics Control (CEC) |
| 29 | $V_{\text {DDC }}$ | DDC Power |
| 20,39,40,55,56 | V $\mathrm{CC3}$ | TMDS Power |
| 30 | DGND | DDC/CEC GND |
| 5,10,15,38,43,46,49,52 | GND | GND |
| 32,42 | $\mathrm{S}_{\text {TMds }}$ S Stdi | Select Pins (TMDS, DDC) |
| 31,41 | /OE ${ }_{\text {tmds }} /$ /OE $_{\text {ddc }}$ | Output Enable (TMDS, DDC) |

## Pin Assignments



Figure 3. Pin Assignments

## Truth Table

| $\mathbf{S}_{\text {TMDS }}$ <br> S $_{\text {DDC }}$ | /OE $_{\text {TMDS, }}$ <br> $/$ OE $_{\text {DDC }}$ | Function |
| :---: | :---: | :--- |
| Don't' Care | Logic Level HIGH | All Ports Disconnected (Hi-Z) |
| Logic Level LOW | Logic Level LOW | 1Dn+/1Dn-=Dn+/Dn-; 1CLK+/ 1CLK-=CLK+/CLK-; HPD1=HPD; SCL1=SCL; <br> SDA1=SDA; CEC1=CEC |
| Logic Level HIGH | Logic Level LOW | 2Dn+/2Dn-=Dn+/Dn-; 2CLK+/ 2CLK-=CLK+/CLK-; HPD2=HPD; SCL2=SCL; <br> SDA2=SDA; CEC2=CEC |

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter |  |  | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{cC3}}$ | Supply Voltage - TMDS Channels |  |  | -0.5 | 4.6 | V |
| V ${ }_{\text {dDC }}$ | Supply Voltage - 5V DDC |  |  | -0.5 | 6.0 | V |
| $\mathrm{V}_{\text {SWTMDS }}{ }^{(1)}$ | Switch I/O Voltage | 1Dn+, 1Dn-, 2Dn+, 2Dn-, Dn+, Dn-, 1CLK+, 1CLK-, 2CLK+, 2CLK-, CLK + , CLK- |  | -0.5 | $\mathrm{V}_{\mathrm{cc} 3}+0.3$ | V |
| $\mathrm{V}_{\text {Swddc }}{ }^{(1)}$ | Switch I/O Voltage | HPD1, HPD2, HPD, SCL1, SCL2, SCL, SDA1, SDA2, SDA, CEC1, CEC2, CEC |  | -0.5 | $V_{D D C}+0.3$ | V |
| $\mathrm{V}_{\text {CNTRLT }}{ }^{(1)}$ | Control Input Voltage | $\mathrm{S}_{\text {tmds, }} / \mathrm{OE}_{\text {TMDS }}$ |  | -0.5 | 4.6 | V |
| $\mathrm{V}_{\text {CNTRLD }}{ }^{(1)}$ | Control Input Voltage | $\mathrm{S}_{\mathrm{DDC}}, / \mathrm{OE}_{\text {DDC }}$ |  | -0.5 | 6.0 | V |
| $\mathrm{I}_{\mathrm{K}}$ | Input Clamp Diode Current |  |  |  | -50 | mA |
| Isw | Switch I/O Current (Continuous) |  |  |  | 128 | mA |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range |  |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| TJ | Maximum Junction Temperature |  |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead Temperature (Soldering, 10 Seconds) |  |  |  | +260 | ${ }^{\circ} \mathrm{C}$ |
| ESD | Human Body Model (JEDEC: JESD22-A114) |  | I/O to GND |  | 8.0 |  |
|  |  |  | All Other Pins |  | 2.5 | kV |
|  | Charged Device Model (JEDEC: JESD22-C101) |  |  |  | 2.0 |  |

## Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol | Parameter | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {cC3 }}$ | TMDS Supply Voltage - 3V | 3.0 | 4.3 | V |
| $V_{\text {DDC }}$ | DDC Supply Voltage | 3.0 | 5.5 | V |
| $V_{\text {CNTRLT }}$ | Control Input Voltage - S Tmds $^{\text {/ }}$ /OE TMds | 0 | $V_{\text {cc3 }}$ | V |
| $V_{\text {CNTRLD }}$ | Control Input Voltage - $\mathrm{S}_{\text {DDC }}$ / $/ \mathrm{OE}_{\text {DDC }}$ | 0 | V ${ }_{\text {DDC }}$ | V |
| $\mathrm{V}_{\text {SWTMDS }}$ | Switch I/O Voltage for HDMI path | $\mathrm{V}_{\text {cc3 }}-0.6$ | $V_{\text {cC3 }}$ | V |
| $\mathrm{V}_{\text {Swdic }}$ | Switch I/O Voltage for DDC path | 0 | $\mathrm{V}_{\text {DDC }}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\text {JA }}$ | Thermal Resistance (Free Air) |  | +80 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## DC Electrical Characteristics

All typical values are for $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{DDC}}=5.0 \mathrm{~V}$ at $25^{\circ} \mathrm{C}$ unless otherwise specified.

| Symbol | Parameter | $\mathrm{V}_{\mathrm{CC} 3} / \mathrm{V}_{\mathrm{DDC}}(\mathrm{V})$ | Conditions | $\mathrm{T}_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| $\mathrm{V}_{\text {IK }}$ | Clamp Diode Voltage | $\begin{aligned} & V_{C C 3}=3.0 \\ & V_{D D C}=5.0 \end{aligned}$ | $\mathrm{l}_{\mathrm{N}}=-18 \mathrm{~mA}$ |  |  | -1.2 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Control Input Voltage High | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=3.0 \text { to } 5.5 \end{aligned}$ |  | 2 |  |  | V |
| VIL | Control Input Voltage Low | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=3.0 \text { to } 5.5 \end{aligned}$ |  |  |  | 0.8 | V |
| loztmis | Off State Leakage TMDS Channels | $\begin{aligned} & V_{C C 3}=3.6 \\ & V_{D C D}=5.5 \end{aligned}$ | $0 \leq \mathrm{V}_{\text {SWTMDS }} \leq \mathrm{V}_{\mathrm{CC}}$ <br> Figure 5 | -1 |  | 1 | $\mu \mathrm{A}$ |
| Iozdoc | Off State Leakage DDC/CEC Channels | $\begin{aligned} & V_{C C 3}=3.6 \\ & V_{D D C}=5.5 \end{aligned}$ | $0 \leq \mathrm{V}_{\text {SWDDC }} \leq \mathrm{V}_{\mathrm{DDC}}$ Figure 5 | -5 |  | 5 | $\mu \mathrm{A}$ |
| lintmds | Control Input Leakage (Stmds, /OE ${ }_{\text {tmds }}$ ) | $\begin{aligned} & V_{C C 3}=3.6 \\ & V_{D D C}=5.5 \end{aligned}$ | $\mathrm{V}_{\text {Swddc }}=0$ to $\mathrm{V}_{\text {cC3 }}$ | -1 |  | 1 | $\mu \mathrm{A}$ |
| IINDDC | Control Input Leakage (SDDC, /OE ${ }_{\text {dDC }}$ ) | $\begin{aligned} & V_{C C 3}=3.6 \\ & V_{D D C}=5.5 \end{aligned}$ | $V_{\text {Swdoc }}=0$ to $\mathrm{V}_{\text {DDC }}$ | -1 |  | 1 | $\mu \mathrm{A}$ |
| Icc3 | Quiescent Supply Current -TMDS | $\begin{aligned} & V_{C C 3}=3.6 \\ & V_{D D C}=5.5 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SWTMDS}}=\mathrm{V}_{\mathrm{CC} 3}-0.6 \\ & \text { or } \mathrm{V}_{\mathrm{CC} 3}, \mathrm{l}_{\mathrm{OUT}}=0 \end{aligned}$ |  |  | 2 | $\mu \mathrm{A}$ |
| IdDC | Quiescent Supply Current -DDC | $\begin{aligned} & V_{C C 3}=3.6 \\ & V_{D D C}=5.5 \end{aligned}$ | $V_{\text {SWDDC }}=0$ or $V_{\text {DDC }}$, lout=0 |  |  | 2 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\text {сстз }}$ | Increase in Icc3 | $\begin{aligned} & V_{C C 3}=3.6 \\ & V_{C C 5}=5.5 \end{aligned}$ | One input at 3.0 V ; Other inputs at $\mathrm{V}_{\mathrm{CC}}{ }^{-}$ 0.6 or $\mathrm{V}_{\mathrm{CC}}$ |  |  | 100 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\text {cсtd }}$ | Increase in IDDC | $\begin{aligned} & \mathrm{V}_{\mathrm{CC} 3}=3.6 \\ & \mathrm{~V}_{\mathrm{CC} 5}=5.5 \end{aligned}$ | One input at 3.0 V ; Other inputs at $V_{D D C}$ |  |  | 15 | $\mu \mathrm{A}$ |

## AC Electrical Characteristics

All typical values are for $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{DDC}}=5.0 \mathrm{~V}$ at $25^{\circ} \mathrm{C}$ unless otherwise specified.

| Symbol | Parameter | $\mathrm{V}_{\mathrm{cc} 3} / \mathrm{V}_{\mathrm{DDC}}(\mathrm{V})$ | Conditions | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to +85${ }^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| TMDS Channels |  |  |  |  |  |  |  |
| tontmbs | Turn-On Time S, /OE to Output | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\mathrm{V}_{\text {SWTMDS }}=\mathrm{V}_{\text {CC3 }}-0.5$, $R_{\text {PU }}=50 \Omega, C_{L}=5 p f$ <br> Figure 6, Figure 7 |  | 4 | 6 | ns |
| tofftmbs | Turn-Off Time S to Output | $\begin{aligned} & V_{C C 3}=3.0 \text { to } 3.6 \\ & V_{D D C}=5.0 \end{aligned}$ | $V_{\text {SWTMDS }}=\mathrm{V}_{\text {CC3 }}-0.5$, $\mathrm{R}_{\mathrm{PU}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pf}$ <br> Figure 6, Figure 7 |  | 2 | 4 |  |
| $\mathrm{t}_{\text {BbM-TMDS }}$ | Break-Before-Make $\text { Time }{ }^{(2)}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $V_{\text {SWTMDS }}=\mathrm{V}_{\text {CC3 }}-0.5$, $R_{P U}=50 \Omega, C_{L}=5 p f$ <br> Figure 15 | 1 |  |  | ns |
| $\mathrm{t}_{\mathrm{pd}}\left(\mathrm{t}_{\mathrm{pLL}}, \mathrm{t}_{\mathrm{p} H L}\right)$ | Switch Propagation Delay ${ }^{(2)}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $R_{P U}=50 \Omega, C_{L}=5 p f$ Figure 14 |  |  | 400 | ps |
| $\mathrm{t}_{\mathrm{j} \text { itter }}$ | Total Jitter (DJ+RJ) | $\begin{aligned} & \mathrm{V}_{\mathrm{CC} 3}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\mathrm{f}=165 \mathrm{MHz}$ clock with 50\% duty cycle, $R_{P U}=50 \Omega, C_{L}=5 p f$ <br> Figure 14 |  |  | 90 | ps |
| tratio | Duty Cycle Ratio | $\begin{aligned} & \mathrm{V}_{\mathrm{CC} 3}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\mathrm{f}=165 \mathrm{MHz}$ clock with 50\% duty cycle, $R_{P U}=50 \Omega, C_{L}=5 p f$ <br> Figure 14 | 40 | 50 | 60 | \% |
| $\mathrm{t}_{\text {SK1 }}$ | Intra-Pair Skew (TMDS $\mathrm{Cn}+$ to Cn -) | $\begin{aligned} & V_{\mathrm{CC}_{3}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\begin{aligned} & \mathrm{f}=1.65 \mathrm{Gbps}, 2^{23}-1 \\ & \text { PRBS, R } \mathrm{PU}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pf} \end{aligned}$ <br> Figure 14 |  | 55 | 100 | ps |
| $\mathrm{t}_{\text {SK2 }}$ | Inter-Pair Skew (Between any two TMDS switch pair paths) | $\begin{aligned} & V_{C C 3}=3.0 \text { to } 3.6 \\ & V_{D D C}=5.0 \end{aligned}$ | $\begin{aligned} & \mathrm{f}=1.65 \mathrm{Gbps}, 2^{23}-1 \\ & \mathrm{PRBS}, \mathrm{RPU}^{2}=50 \Omega \text {, } \\ & \mathrm{C}_{\mathrm{L}}=5 \mathrm{pf} \end{aligned}$ <br> Figure 14 |  | 90 | 160 | ps |
| OIRR $_{\text {tmds }}$ | Off-Isolation (TMDS Channels) | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\mathrm{R}_{\mathrm{T}}=50 \Omega, \mathrm{f}=370 \mathrm{MHz}$ <br> Figure 10 | -30 |  |  | dB |
|  |  | $\begin{aligned} & V_{\mathrm{CC}_{3}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\mathrm{R}_{\mathrm{T}}=50 \Omega, \mathrm{f}=825 \mathrm{MHz}$ <br> Figure 10 | -25 |  |  |  |
| Xtalk ${ }_{\text {TMDS }}$ | Non-Adjacent Channel Crosstalk (TMDS Channels) | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\mathrm{R}_{\mathrm{T}}=50 \Omega, \mathrm{f}=370 \mathrm{MHz}$ <br> Figure 11 | -25 |  |  | dB |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC} 3}=3.0 \text { to } 3.6 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ | $\mathrm{R}_{\mathrm{T}}=50 \Omega, \mathrm{f}=825 \mathrm{MHz}$ <br> Figure 11 | -20 |  |  |  |
| $\mathrm{f}_{\text {max }}$ | Maximum Throughput ${ }^{(2)}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC} 3}=3.3 \\ & \mathrm{~V}_{\mathrm{DDC}}=5.0 \end{aligned}$ |  |  | 1.65 |  | Gbps |
| Control Channels - DDC / CEC |  |  |  |  |  |  |  |
| tonddc | Turn-On Time; Sddc, /OE ${ }_{\text {dDc }}$ to Output | $\begin{aligned} & V_{C C 3}=3.3 \\ & V_{D D C}=3.0 \text { to } 5.5 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SWDDC}}=2 \mathrm{~V}, \mathrm{R}_{\mathrm{DDC}}=1 \mathrm{k} \Omega, \\ & \mathrm{C}_{\mathrm{L}}=5 \mathrm{pf} \end{aligned}$ |  |  | 28 | ns |
| toffdic | Turn-Off Time; SDDC, $/ O E_{D D C}$ to Output | $\begin{aligned} & V_{C C 3}=3.3 \\ & V_{D D C}=3.0 \text { to } 5.5 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SWDDC}}=2 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \\ & \mathrm{C}_{\mathrm{L}}=5 \mathrm{pf} \end{aligned}$ |  |  | 24 | ns |

## Note:

2. Guaranteed by characterization, not production tested.

## Test Diagrams



Figure 4. On Resistance


Each switch port is tested separately.

Figure 5. Off Leakage

$R_{P U}$ and $C_{L}$ are functions of the application environment
(see AC/DC tables for values of $C_{L}$ and $R_{P U}$ ).
$\mathrm{C}_{\mathrm{L}}$ includes test fixture and stray capacitance.

Figure 6. TMDS Test Circuit Load


Figure 7. DDC Test Circuit Load

## Test Diagrams



Figure 8. Turn-on / Turn-off Waveforms


Figure 9. DDC Turn-on / Turn-off Waveforms


Figure 10. Channel Off Isolation


Figure 11. Non-Adjacent Channel-to-Channel Crosstalk

## Test Diagrams



Figure 12. Channel Off Capacitance


Figure 13. Channel On Capacitance


Figure 14. Intra- and Inter-Pair Skew $\mathbf{t}_{\mathrm{pd}}$

$R_{P U}$ and $C_{L}$ are functions of the application
environment (see $A C / D C$ tables for values).
$C_{L}$ includes test fixture and stray capacitance


Figure 15. Break Before Make

## Physical Dimensions



NOTES:
A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION EE, REF NOTE 6, DATE 10/97.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982. ${ }^{0.60 \pm 0.10}$


## MTD56REV3

## DETAIL A

Figure 16. 56-Pin Thin-Shrink Small Outline Package (TSSOP)

[^1]
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| Build it Nown ${ }^{\text {TM }}$ | FRFET ${ }^{\text {® }}$ | Programmable Active Droop ${ }^{\text {m }}$ | P wer |
| CorePLUSTM | Global Power Resource ${ }^{\text {SM }}$ | QFET ${ }^{\text {® }}$ | tranchisa |
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| CROSSVOLTM | Green $\mathrm{FPS}^{\text {m }} \mathrm{e}$-Series ${ }^{\text {™ }}$ | Quiet Series ${ }^{\text {TM }}$ | TinyCalc ${ }^{\text {m }}$ |
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| EZSMMTCH ${ }^{\text {ma }}$ | ISOPLANAR ${ }^{\text {M }}$ M ${ }^{\text {a }}$ | SignalWise ${ }^{\text {Tm }}$, | TinyPWM ${ }^{\text {™ }}$ |
|  | MegaBuck ${ }^{\text {m }}$ ( ${ }^{\text {a }}$ | SmartMax ${ }^{\text {TM }}$ | Tiny Mire ${ }^{\text {™ }}$ |
| E? | MICROCOUPLER ${ }^{\text {m }}$ | SMART STARTTM | TriFault Detect ${ }^{\text {TM }}$ |
| $5^{8}$ |  | SPM ${ }^{\text {® }}$ | TRUECURRENT ${ }^{\text {TM* }}$ |
|  | MillerDrive ${ }^{\text {TM }}$ | STEALTH ${ }^{\text {TM }}$ | $\mu$ SerDes ${ }^{\text {TM }}$ |
| Fairchild ${ }^{\text {® }}$ | MotionMax ${ }^{\text {TM }}$ | SuperFETM | M |
| Fairchild Semiconductor ${ }^{\text {® }}$ | Motion-SPM ${ }^{\text {TM }}$ | SuperSOTTM 3 | SerDes |
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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

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| :--- | :--- | :--- |
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